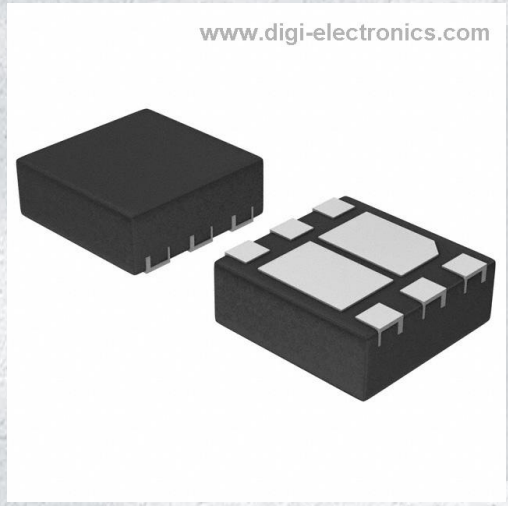
NSV20200DMTWTBG Datasheet



DiGi Electronics Part Number	NSV20200DMTWTBG-DG
Manufacturer	onsemi
Manufacturer Product Number	NSV20200DMTWTBG
Description	TRANS NPN 20V 6WDFN
Detailed Description	Bipolar (BJT) Transistor Array 2 PNP (Dual) 155MHz Surface Mount 6-WDFN (2x2)

https://www.DiGi-Electronics.com

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NSV20200DMTWTBG	onsemi
Series:	Product Status:
-	Active
Transistor Type:	Vce Saturation (Max) @ Ib, Ic:
2 PNP (Dual)	390mV @ 200mA, 2A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
100nA (ICBO)	250 @ 100mA, 2V
Frequency - Transition:	Operating Temperature:
155MHz	-55°C ~ 150°C (TJ)
Mounting Type:	Package / Case:
Surface Mount	6-WDFN Exposed Pad
Supplier Device Package:	Base Product Number:
6-WDFN (2x2)	NSV20200

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0075	

onsemi

DATA SHEET
www.onsemi.com

Low $V_{CE(sat)}$ PNP Transistors
20 V, 2 A

NSS20200DMT

onsemi's e²PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC−DC converters and LED lightning, power management…etc. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable
- NSV20200DMTWTBG − Wettable Flanks Device
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector−Emitter Voltage	V_{CEO}	20	Vdc
Collector−Base Voltage	V_{CBO}	20	Vdc
Emitter−Base Voltage	V_{EBO}	7	Vdc
Collector Current − Continuous	I_C	2	A
Collector Current − Peak	I_{CM}	3	A

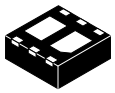
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction−to−Ambient (Notes 1 and 2)	$R_{\theta JA}$	60	°C/W
Total Power Dissipation per Package @ T_A = 25°C (Note 2)	P_D	2.10	W
Thermal Resistance Junction−to−Ambient (Note 3)	$R_{\theta JA}$	79	°C/W
Power Dissipation per Transistor @ T_A = 25°C (Note 3)	P_D	1.59	W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

1. Per JESD51−7 with 100 mm² pad area and 2 oz. Cu (Dual Operation).
2. P_D per Transistor when both are turned on is one half of Total P_D or 1.13 Watts.
3. Per JESD51−7 with 100 mm² pad area and 2 oz. Cu (Single−Operation).

20 Volt, 2 Amp
PNP Low $V_{CE(sat)}$ Transistors


1

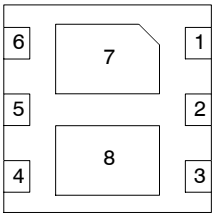
WDFN6
CASE 506AN

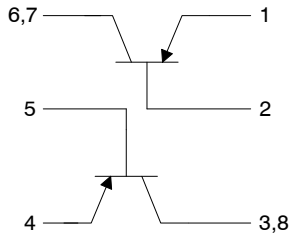
MARKING DIAGRAM

AT = Specific Device Code
M = Date Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS





ORDERING INFORMATION

Device	Package	Shipping†
NSS20200DMTTBG	WDFN6 (Pb−Free)	3000 / Tape & Reel
NSV20200DMTWTBG	WDFN6 (Pb−Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NSS20200DMT

Table 1. ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector−Emitter Breakdown Voltage (I_C = −10 mA, I_B = 0)	$V_{(BR)CEO}$	−20			V
Collector−Base Breakdown Voltage (Ic = −0.1 mA, I_E = 0)	$V_{(BR)CBO}$	−20			V
Emitter−Base Breakdown Voltage (I_E = −0.1 mA, I_C = 0)	$V_{(BR)EBO}$	−7			V
Collector Cutoff Current (V_{CB} = −60 V, I_E = 0)	I_{CBO}			−100	nA
Emitter Cutoff Current (V_{BE} = −5.0 V)	I_{EBO}			−100	nA
ON CHARACTERISTICS					
DC Current Gain (Note 4) (I_C = −100 mA, V_{CE} = −2.0 V) (I_C = −500 mA, V_{CE} = −2.0 V) (I_C = −1 A, V_{CE} = −2.0 V) (I_C = −2 A, V_{CE} = −2.0 V	h_{FE}	 250 210 160 100			
Collector−Emitter Saturation Voltage (Note 4) (I_C = −500 mA, I_B = −50 mA) (I_C = −700 mA, I_B = −7 mA) (I_C = −1 A, I_B = −50 mA) (I_C = −2 A, I_B = −200 mA)	$V_{CE(sat)}$			 −0.11 −0.20 −0.22 −0.39	V
Base − Emitter Saturation Voltage (Note 4) (I_C = −500 mA, I_B = −50 mA) (I_C = −1 A, I_B = −50 mA) (I_C = −1 A, I_B = −100 mA)	$V_{BE(sat)}$			 −1.0 −1.1 −1.2	V
Base−Emitter Turn−on Voltage (Note 4) (I_C = 500 mA, I_B = 50 mA)	$V_{BE(on)}$			−0.9	V
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 10 V, f = 1.0 MHz)	C_{obo}		18		pF
Cutoff Frequency (I_C = 50 mA, V_{CE} = 2.0 V, f = 100 MHz)	f_T		155		MHz
SWITCHING TIMES					
Delay Time (V_{CC} = −10 V, I_C = −0.5 A, I_{B1} = −25 mA, I_{B2} = 25 mA)	t_d		15		ns
Rise Time (V_{CC} = −10 V, I_C = −0.5 A, I_{B1} = −25 mA, I_{B2} = 25 mA)	t_r		13		ns
Storage Time (V_{CC} = −10 V, I_C = −0.5 A, I_{B1} = −25 mA, I_{B2} = 25 mA)	t_s		360		ns
Fall Time (V_{CC} = −10 V, I_C = −0.5 A, I_{B1} = −25 mA, I_{B2} = 25 mA)	t_f		22		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%

NSS20200DMT

TYPICAL CHARACTERISTICS

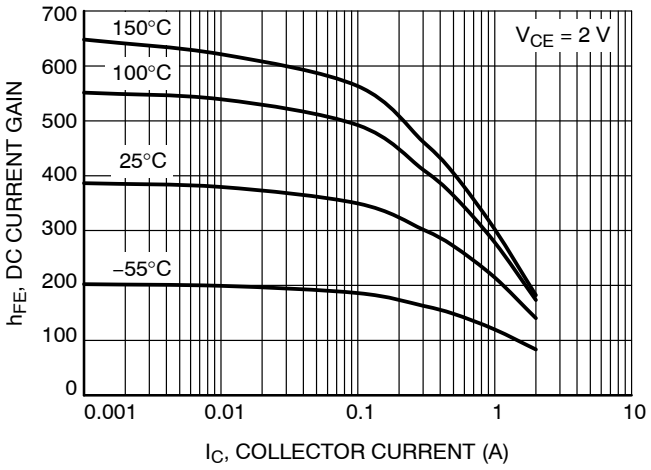


Figure 1. DC Current Gain

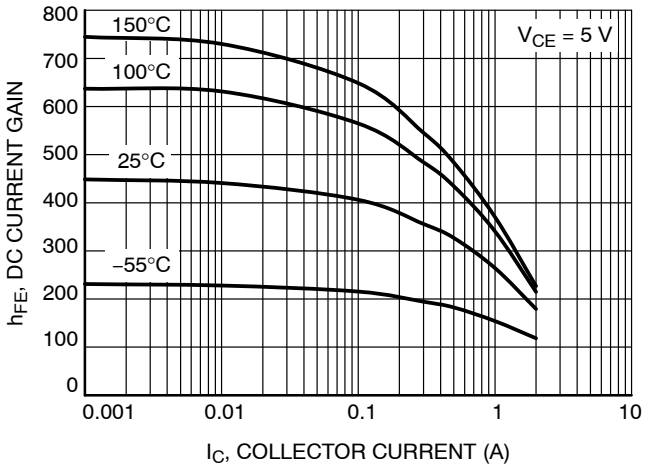


Figure 2. DC Current Gain

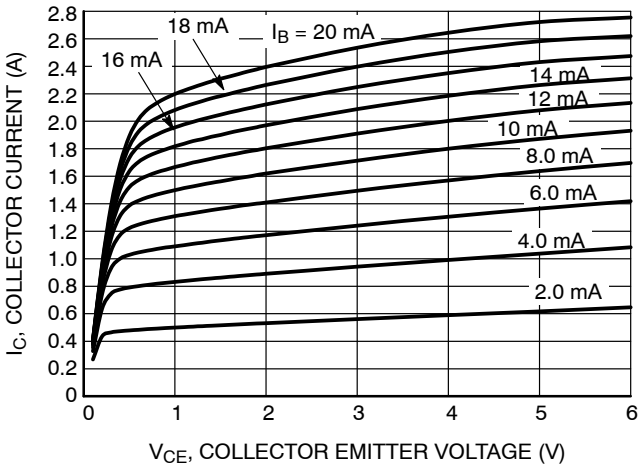


Figure 3. Collector Current as a Function of Collector Emitter Voltage

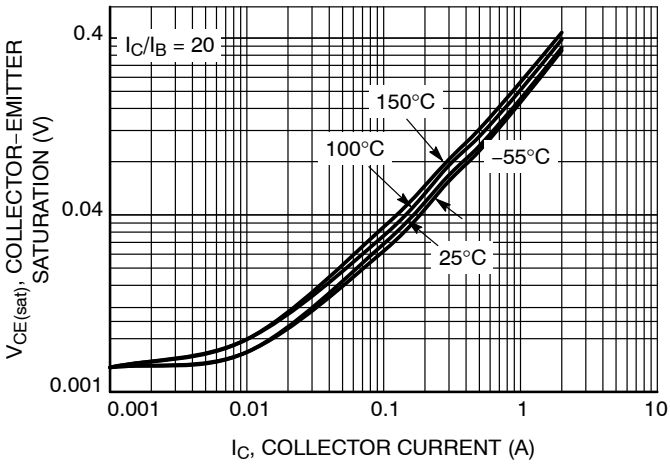


Figure 4. Collector−Emitter Saturation Voltage

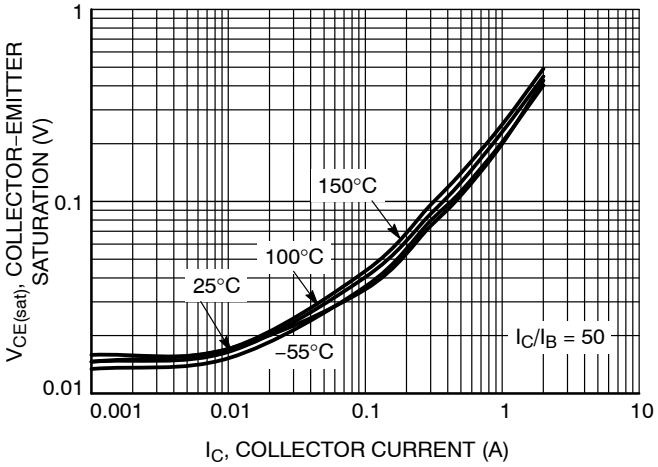


Figure 5. Collector−Emitter Saturation Voltage

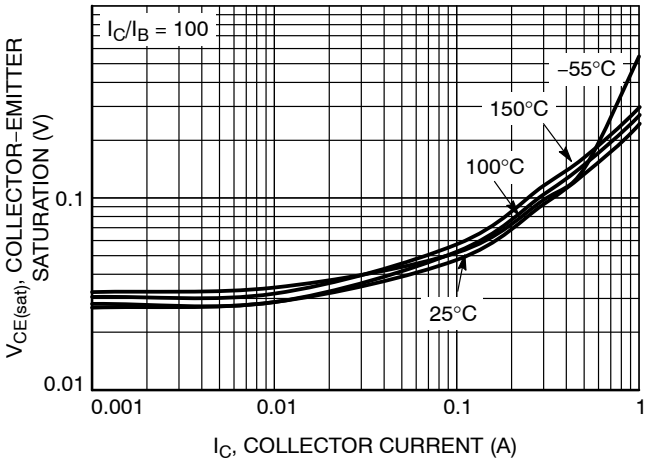


Figure 6. Collector−Emitter Saturation Voltage

TYPICAL CHARACTERISTICS

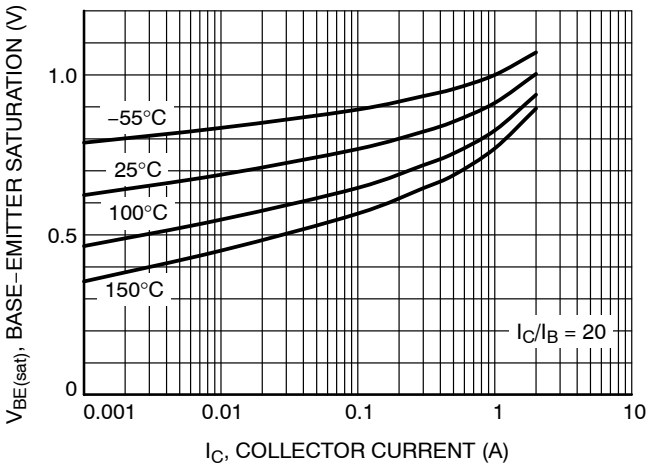


Figure 7. Base−Emitter Saturation Voltage

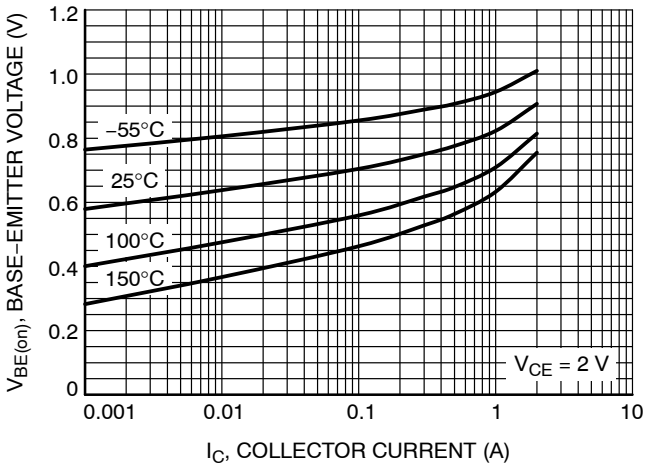


Figure 8. Base−Emitter "ON" Voltage

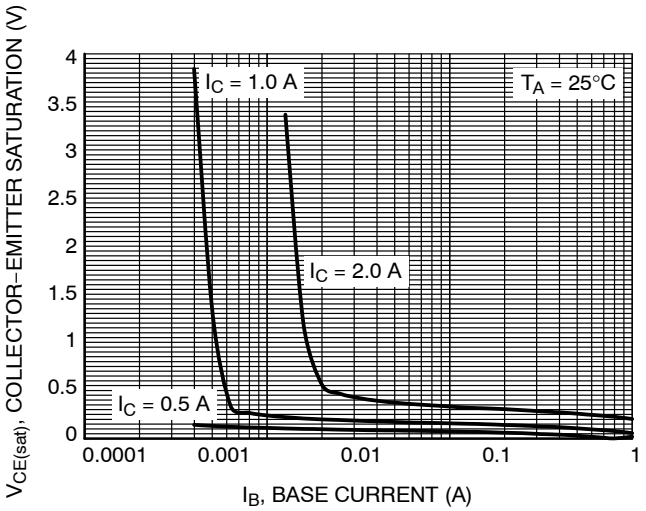


Figure 9. Collector Saturation Region

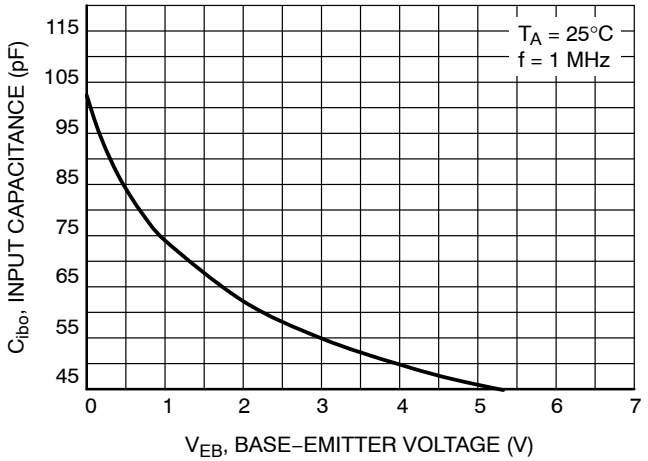


Figure 10. Input Capacitance

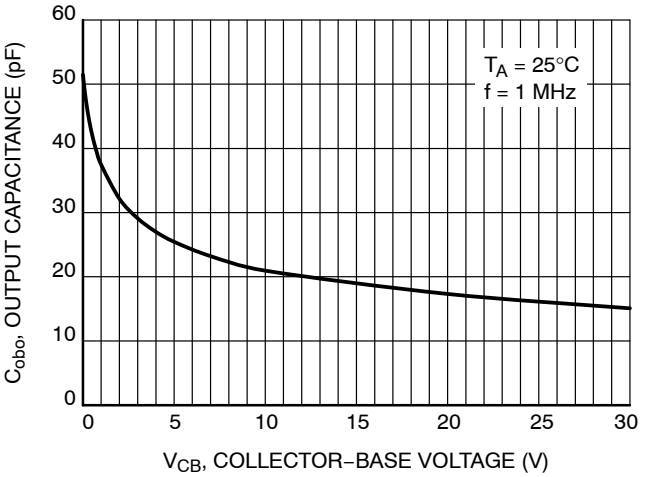


Figure 11. Output Capacitance

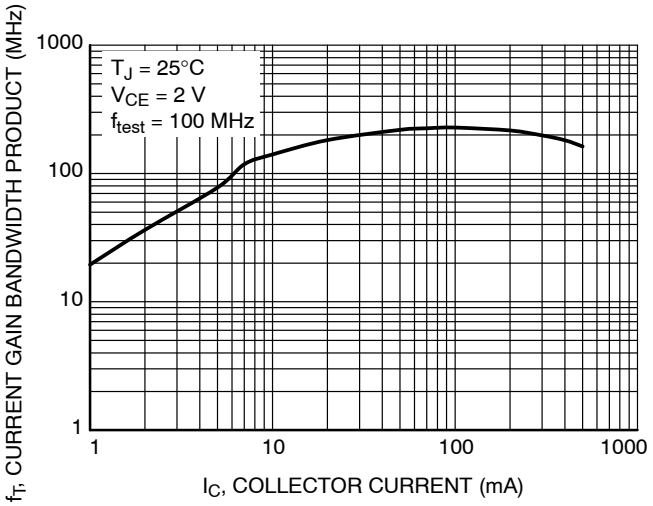


Figure 12. f_T, Current Gain Bandwidth Product

TYPICAL CHARACTERISTICS

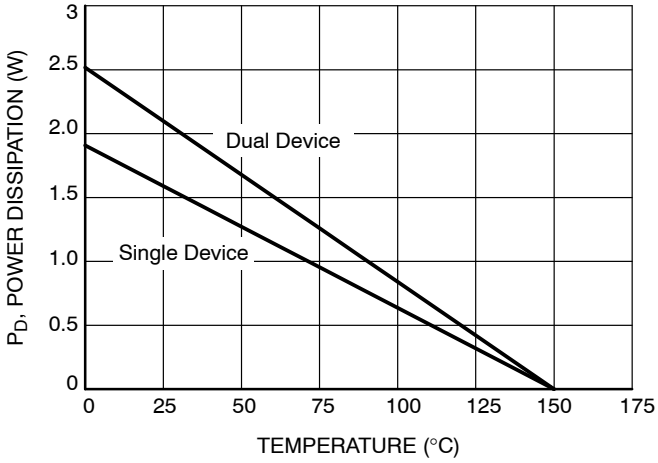


Figure 13. Power Derating

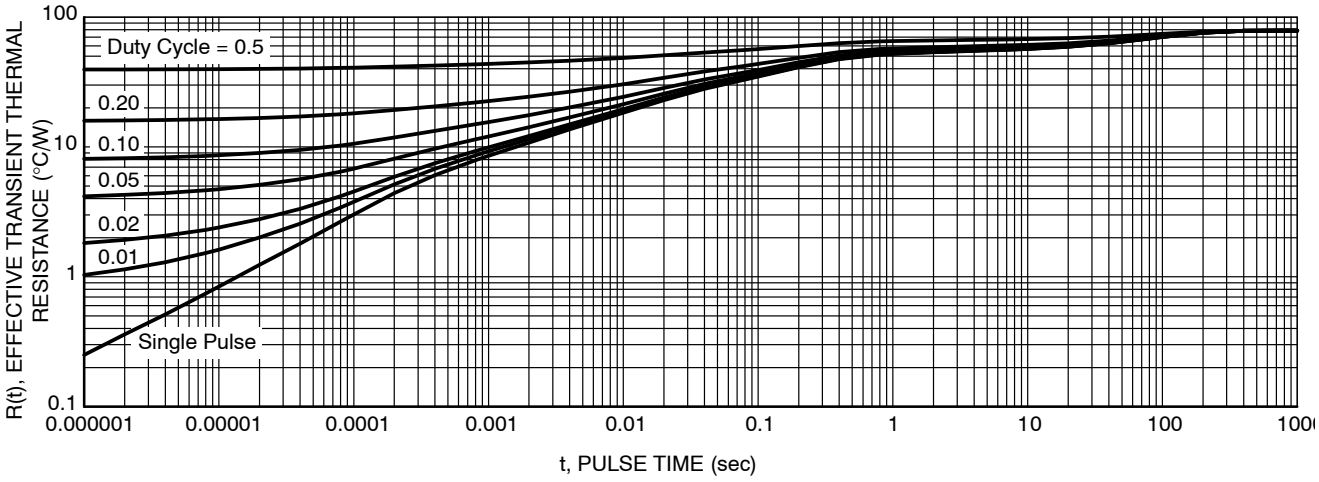


Figure 14. Thermal Resistance by Transistor

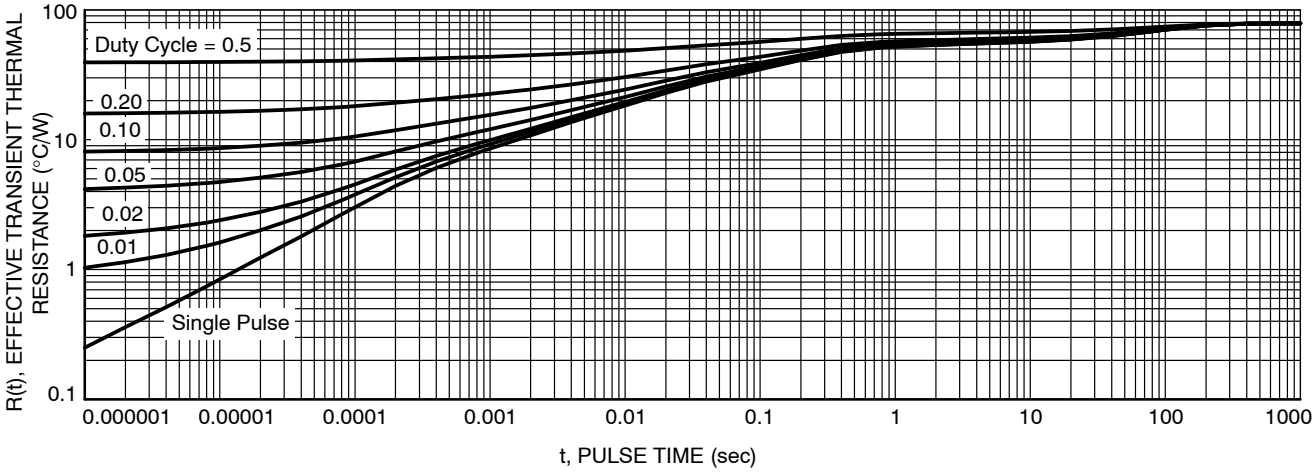
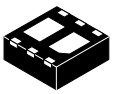


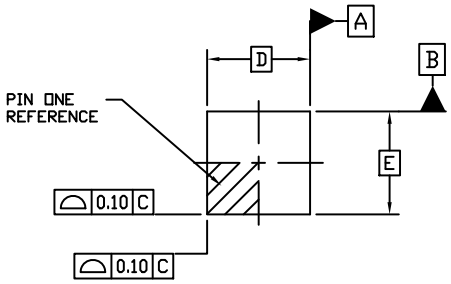
Figure 15. Thermal Resistance for Both Transistors

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS



WDFN6 2x2, 0.65P
CASE 506AN
ISSUE H

DATE 25 JAN 2022

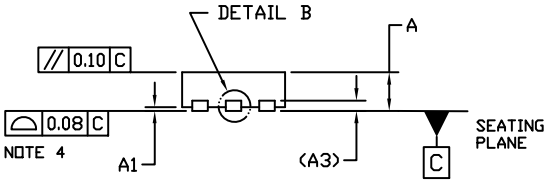


TOP VIEW

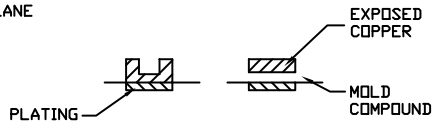
DETAIL A
OPTIONAL CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.

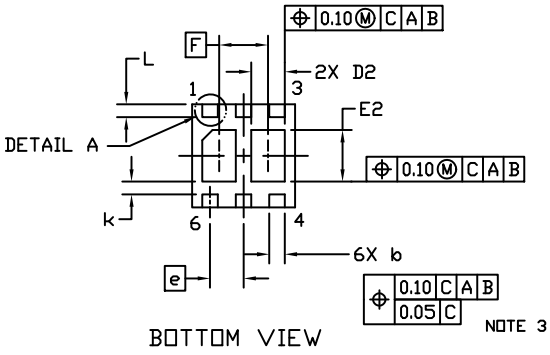


SIDE VIEW

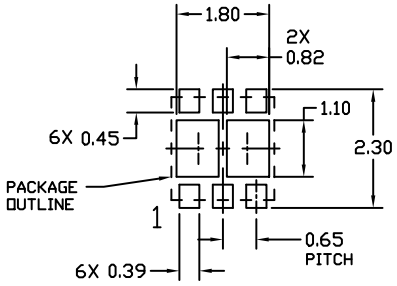


DETAIL B
OPTIONAL CONSTRUCTIONS

DIM	MILLIMETERS	
	MIN.	MAX.
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.25	0.35
D	2.00 BSC	
D2	0.57	0.77
E	2.00 BSC	
E2	0.90	1.10
e	0.65 BSC	
F	0.95 BSC	
k	0.25 REF	
L	0.20	0.30
L1	---	0.10



BOTTOM VIEW



RECOMMENDED
MOUNTING FOOTPRINT
SOLDERMASK DEFINED

GENERIC MARKING DIAGRAM*

XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	**98AON20861D**	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped “CONTROLLED COPY” in red.	
DESCRIPTION:	**WDFN6 2x2, 0.65P**		**PAGE 1 OF 1**

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OUR CERTIFICATE

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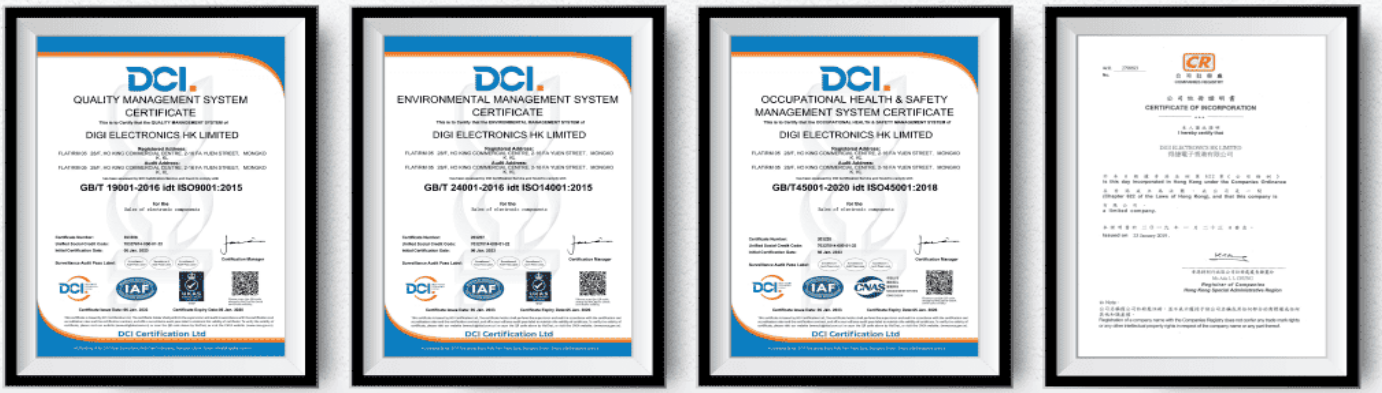

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